

Docket No.

Armstrong, Westerman & Hattori, LLP

DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

(Application Serial No.)

My residence, post office address and citizenship are as stated below next to my name.

and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §		ral names are listed below) o		s listed below) or an original, is claimed and for which a p	
was filed on as United States Application Number or PCT International Application Number and was amended on (if applicable). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred above. I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56. I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign applications) for patent or inventor's certificate histed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed. Priority Claimed (List prior foreign applications. See note A below)	HEAT-SE	NSITIVE LITHOGRAPHI	C PRINTING PLATE	AND IMAGE FORMING	METHOD
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I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:



PATENT TRADEMARK OFFICE

Please direct all communications to the following address:



ENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C)	Full name of sole or first inventor (given name, family name)		Yasuyuki WATANABE			
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		Chiba-ken, Japan				
	Full name of second	inventor (given name, family name)	Naohito SAITO			
	Inventor's signature	Notito Saito	Date September 1,2003			
	Residence	Sakura-shi, Japan	Citizenship Japanese			
	Post Office Address	ost Office Address 27-8, Haruji 2-chome, Sakura-shi, Chiba-ken, Japa				
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	Inventor's signature Residence	Hisatomo Yonehara	Date September 1, 2003			
		Sakura-shi, Japan	Citizenship Japanese			
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	Full name of fourth inventor (given name, family name)		Yasuyuki SUZUKI			
	Inventor's signature	Yasuvub: Smuki	Date September 1, 2003			
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	Full name of fifth inventor (given name, family name)					
	Inventor's signature		Date			
	Residence		Citizenship			
	Post Office Address					
						